# Display Elektronik GmbH

# DATA SHEET

TFT MODULE

**DEM 1280800D VMH-PW-N** 

10,1" TFT

Product Specification

Version: 0

**Revision History** 

Date	Rev. No.	Page	Summary
13.12.2024	0	ALL	FIRST ISSUE

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### \* Description

This is a color active matrix TFT (Thin Film Transistor) LCD (liquid crystal display) that uses amorphous silicon TFT as a switching device. This module is composed of a Transmissive type TFT-LCD Panel, driver circuit, back-light unit. The resolution of a 10.1 "TFT-LCD contains 1280x800 pixels, and can display up to 16.7M colors.

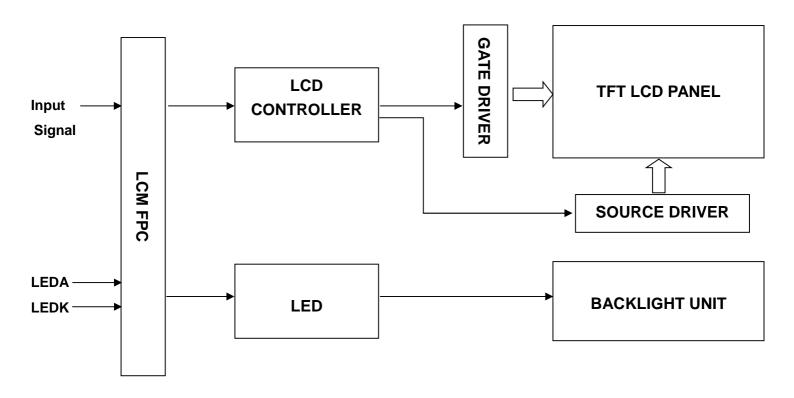
#### \* Features

General Information	Specification	- Unit	Note
Items	Main Panel	- Offic	Note
Display area(AA)	216.96(H)*135.6(V) (10.1 inch)	mm	
Driver element	TFT active matrix	-	
Display colors	16.7M	colors	
Number of pixels	1280(RGB)*800	dots	
Pixel arrangement	RGB vertical stripe	-	
Pixel pitch	0.1692(H)*0.1692(V)	mm	
Viewing angle	ALL	o'clock	
LCM Interface	8BIT LVDS	-	
Display mode	Transmissive /Normally Black	-	
Operating temperature	-20~+70	$^{\circ}$ C	
Storage temperature	-30∼+85	$^{\circ}$ C	

### \* Mechanical Information

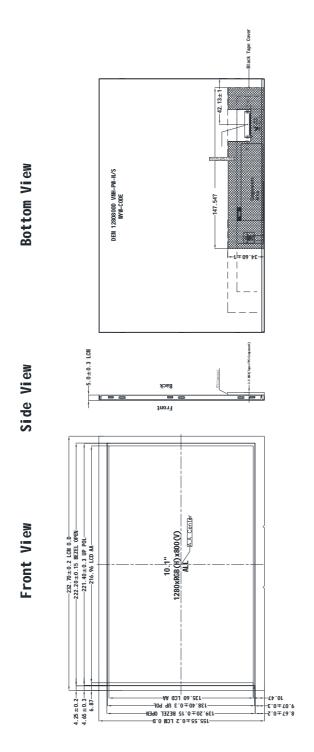
	Item	Min.	Тур.	Max.	Unit	Note
Madula	Horizontal(H)	-	232.70	-	mm	
Module size	Vertical(V)	-	155.55	-	mm	
Size	Depth(D)	-	5.0	-	mm	
	Weight	-	290	-	g	

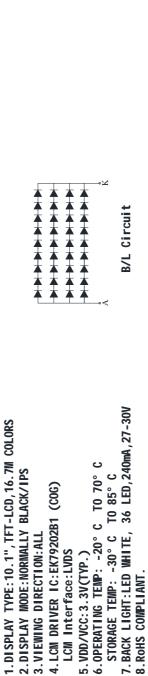
# 1. Block Diagram



### 2. Outline dimension

Pin Name	NC	VDD	VDD	NC	NC	NC	GND	RXIN0-	RXIN0+	GND	RXIN1-	RXIN1+	GND	RXIN2-	RXIN2+	GND	RXCLK-	RXCLK+	GND	RXIN3-	RXIN3+	GND	NC	LED.	LED.	NC	NC	NC	NC	NC	NC	VLED+	010							
NO.	-	2	3	4	2	9	7	8	6	10	11	12	13	14	15	16	17	18	19	80	22	Ø	23	24	22	78	Z	88	82	30	31	32	33	34	32	36	37	38	39	





# 3. Input terminal Pin Assignment

NO.	SYMBOL	DISCRIPTION	I/O
1	NC	Not Connect	
2	VDD	A nowan awards for analog sires it VDD 2.2V	Б
3	VDD	A power supply for analog circuit. VDD=3.3V;	P
4	NC	Not Connect	
5	NC	Not Connect	
6	NC	Not Connect	
7	GND	Ground	Р
8	RXIN0-	LVDS data Input	I
9	RXIN0+	LVDS data Input.	I
10	GND	Ground	Р
11	RXIN1-	LVDS data Input.	I
12	RXIN1+	LVD3 data input.	I
13	GND	Ground	Р
14	RXIN2-	LVDS data Input.	I
15	RXIN2+	LVD3 data input.	I
16	GND	Ground	Р
17	RXCLK-	LVDS clock Input.	I
18	RXCLK+	EV DO GIOCK III put.	I
19	GND	Ground	Р
20	RXIN3-	LVDS data Input.	I
21	RXIN3+	EVDO data input.	I
22	GND	Ground	Р
23	NC	Not Connect	
24	NC	Not Connect	
25	NC	Not Connect	
26	NC	Not Connect	
27	NC	Not Connect	
28	NC	Not Connect	
29	NC	Not Connect	
30	NC	Not Connect	
31	LED-	LED Cathode	Р
32	LED-	LED Cathode	Р
33	NC	Not Connect	
34	NC	Not Connect	
35	NC	Not Connect	

# **DEM 1280800D VMH-PW-N**

# **Product Specification**

36	NC	Not Connect	
37	NC	Not Connect	
38	NC	Not Connect	
39	LED+	LED Anode	Р
40	LED+	LED Anode	Р

## 4. LCD Optical Characteristics

## 4.1 Optical specification

Item		Symbol	Condition	Min.	Тур.	Max.	Unit.	Note
Contrast R	atio	CR	Θ=0	800	1000			CA-310
Response time	Rising Falling	$T_R+T_F$	Normal viewing angle		25	35	msec	*
Color gan	nut	S(%)		45	50		%	*
		Wx			0.317			CA-310
	White	W <sub>Y</sub>			0.338			
		R <sub>X</sub>			0.599			
Color Filter	Red	R <sub>Y</sub>		0.04	0.353	0.04		
Chromacicity		Gx		-0.04	0.355	+0.04		
((CIE 1931))	Green	G <sub>Y</sub>			0.550			
		B <sub>X</sub>			0.147			
	Blue	B <sub>Y</sub>			0.114			
		ΘL		70	80			
	Hor.	ΘR		70	80			
Viewing angle	.,	ΘU	CR>10	70	80			
	Ver.	ΘD		70	80			
Option View D	irection			ALL				

<sup>\*</sup> The data comes from the LCD specification.

#### **Measuring Condition**

Measuring surrounding : dark room

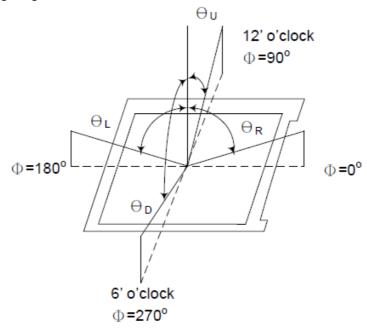
Ambient temperature: 25±2°C

15min. warm-up time.

#### **Measuring Equipment**

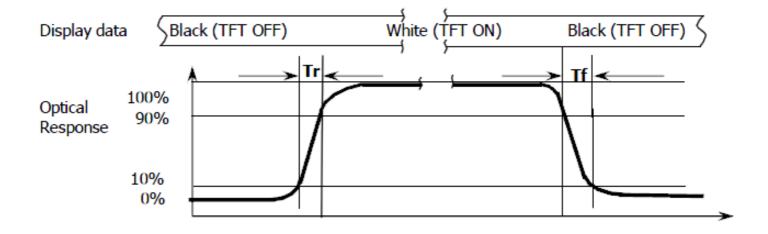
FPM520 of Westar Display technologies, INC., which utilized SR-3 for Chromaticity and BM-5A for other optical characteristics.

#### Note (1): Definition of Viewing Angle:

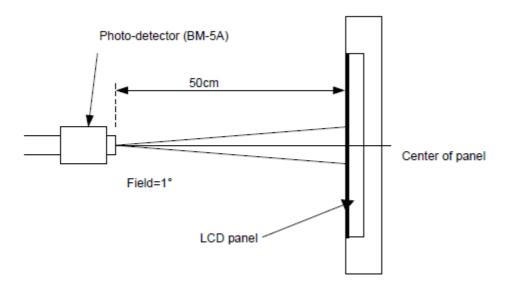


Note (2): Definition of Contrast Ratio(CR) :measured at the center point of panel

Note (3): Response Time



Note (4): Definition of optical measurement setup



### 5. Electrical Characteristics

#### **5.1 Absolute Maximum Rating**

Characteristics	Symbol	Min.	Max.	Unit	Note
Digital Supply Voltage	VDD	-0.5	4	V	Note1
Operating temperature	Тор	-20	+70	°C	
Storage temperature	T <sub>ST</sub>	-30	+85	°C	

NOTE1: If the absolute maximum rating of even is one of the above parameters is exceeded even momentarily, the quality of the product may be degraded. Absolute maximum ratings, therefore, specify the values exceeding which the product may be physically damaged. Be sure to use the product within the range of the absolute maximum ratings.

#### 5.2 DC Electrical Characteristics

Characteristics	Symbol	Min.	Тур.	Max.	Unit	Note
Digital Supply Voltage	VDD	-	3.3	-	V	
Normal mode Current	IDD		173		mA	
	ViH	0.8*VDD		VDD	V	
Level input voltage	VıL	GND		0.2*VDD	V	

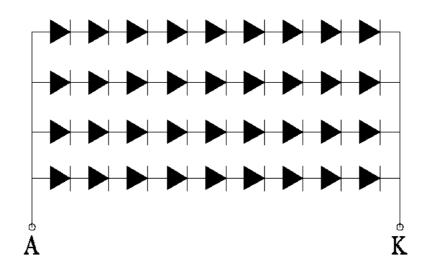
#### 5.3 LED Backlight Characteristics

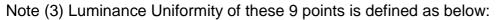
The back-light system is edge-lighting type with 36 chips LED

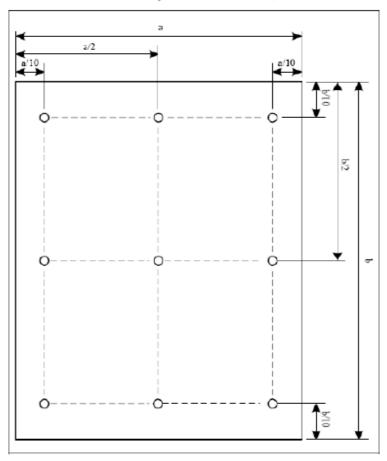
Item	Symbol	Min.	Тур.	Max.	Unit	Note
Forward Current	lF		240		mA	
Forward Voltage	VF		27	30	V	
LCM Luminance	LV	950	1000		cd/m2	Note3
LED life time	Hr	50000			Hour	Note1,2
Uniformity	Avg	70	80		%	Note3

Note1: LED life time (Hr) can be defined as the time in which it continues to operate under the condition: Ta=25±3 °C, typical IL value indicated in the above table until the brightness becomes less than 50%.

Note 2: The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25°C and IL=240mA. The LED lifetime could be decreased if operating IL is larger than 240mA. The constant current driving method is suggested.







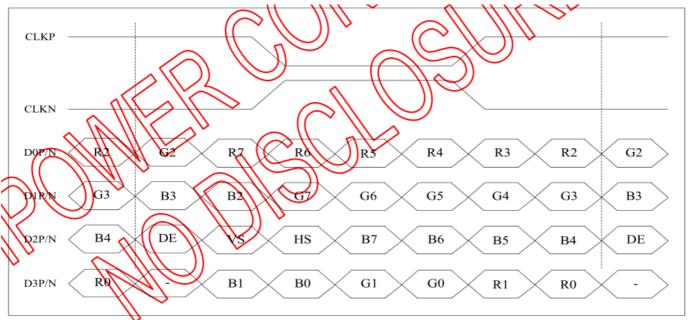
Uniformity =  $\frac{\text{minimum luminance in 9 points (1-9)}}{\text{maximum luminance in 9 points (1-9)}}$ 

Luminance = Total Luminance of 9 points 9

# 6. Video Interface and Timing Table

### 6.1 LVDS interface

## 6.1.1 Data input format for LVDS



8-bit LVDS input (LVBIT=H, LVFMT=L)

# 6.1.2 LVDS Input Timing Table

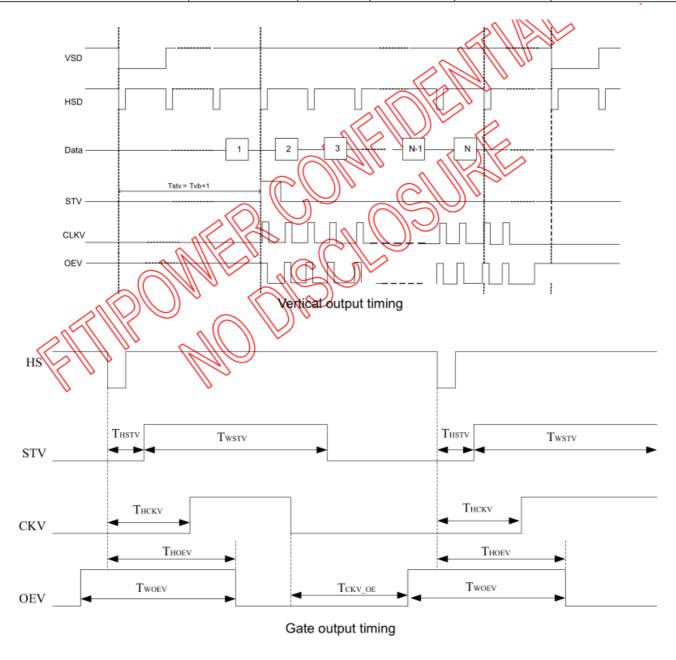
### For 1280RGBx800

Doromotor		Cymphol		Value		Linit
Parameter		Symbol	Min.	Тур.	Max.	Unit
DCLK frequency @Frame rate>6	60Hz (LVDS)	FDCLK	66.3	72.4	78.9	MHz
HSYNC period time		Тн	1380	1440	1500	DCLK
Horizontal display are	а	T <sub>HD</sub>		1280		DCLK
	Min.			2		
HSYNC pulse width	Тур.	THPW		-		
	Max.			40		
HSYNC back porch(with puls	se width)	Тнвр	88	88	88	DCLK
HSYNC front porch		THEP	12	72	132	DCLK
VSYNC period time		T <sub>V</sub>	824	838	872	Н
Vertical display area		T <sub>VD</sub>		800		Н
	Min.			2		Н
VSYNC pulse width	Тур.	TVPW		-		
	Max.			20		
VSYNC back porch(with puls	se width)	T <sub>VBP</sub>	23	23	23	Н
VSYNC front porch		TVFP	1	15	49	Н

# **6.1.3 Gate Output Timing Table**

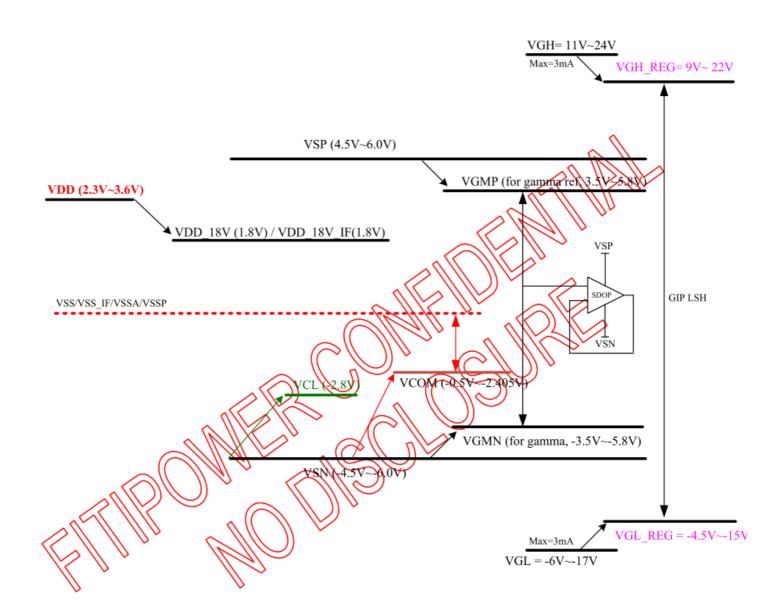
(VDD=2.3 to 3.6V, VSS=VSSA=VSS IF=0V, TA=-20 to  $+85^{\circ}$ C)

Parameter	Symbol	Min.	Тур.	Max.	Unit
STV Pulse Width	Twstv	-	1	-	Н
Time from HSD to STV	THSTV	-	2	-	DCLK
Time from HSD to CKV	Тнску	-	25	-	DCLK
Time from HSD to OEV	THOEV	-	35	-	DCLK
Time from CKV to OEV	Тску_ое	-	168	-	DCLK
OEV Pulse Width	Twoev	-	188	-	DCLK



# 7. Power Sequence and External Power Circuit

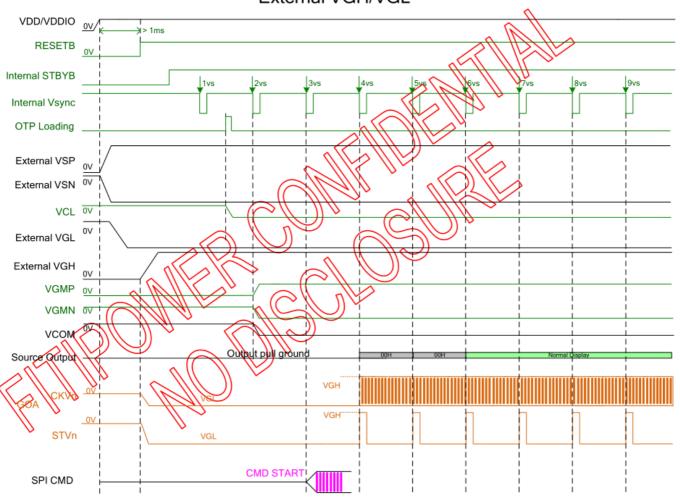
### 7.1 Power Generation



power generation

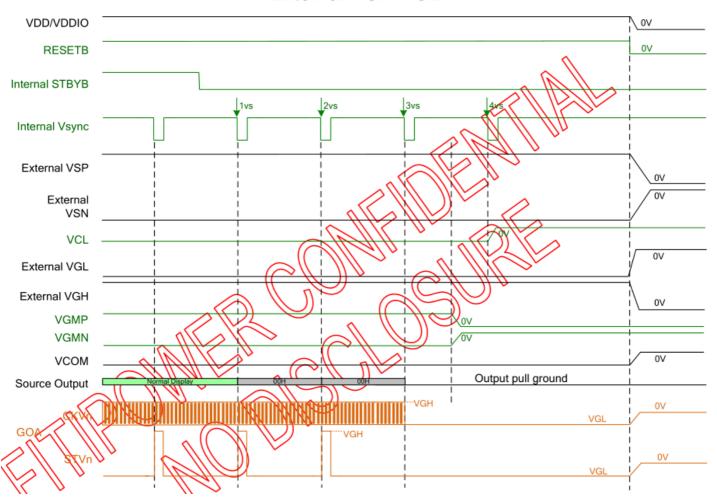
# 7.2 Power on sequence7.2.1 Power on sequence

# External VSP/VSN External VGH/VGL



# 7.2.2 Power off sequence

## External VSP/VSN External VGH/VGL



### 8. LCD Module Out-Going Quality Level

#### 8.1 VISUAL & FUNCTION INSPECTION STANDARD

#### 8.1.1 Inspection conditions

Inspection performed under the following conditions is recommended.

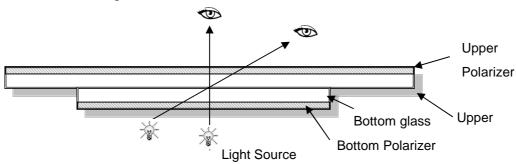
Temperature :  $25\pm5^{\circ}$ C

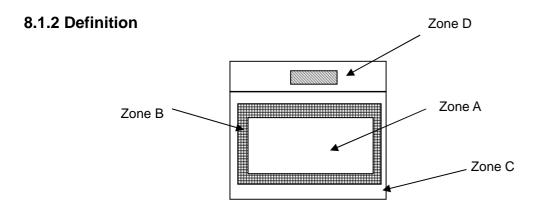
Humidity: 65%±10%RH

Viewing Angle: Normal viewing Angle.

Illumination: Single fluorescent lamp (300 to 700Lux)

Viewing distance:30-50cm





Zone A: Effective Viewing Area(Character or Digit can be seen)

Zone B: Viewing Area except Zone A

Zone C: Outside (Zone A+Zone B) which can not be seen after assembly by customer.)

Zone D: IC Bonding Area

Note:As a general rule ,visual defects in Zone C can be ignored when it doesn't effect product function or appearance after assembly by customer

### 8.1.3 Sampling Plan

According to GB/T 2828-2003 ; , normal inspection, Class  $\,$  II AQL:

Major defect	Minor defect
0.65	1.5

LCD: Liquid Crystal Display , LCM: Liquid Crystal Module

No	Items to be inspected	Criteria	Classification of defects	
		1) No display, Open or miss line		
1	Functional defects	2) Display abnormally, Short		
'	Functional defects	3) Backlight no lighting, abnormal lighting.		
		etc	Major	
2	Missing	Missing components and etc	.,,	
		Overall outline dimension beyond the drawing		
3	3 Outline dimension	is not allowed, deformation and etc		
4	Color tone	Color unevenness, refer to limited sample		
		Light dot,Dim spot,(Note1)		
5	Spot/Line defect	Polarizer Air Bubble,		
		Polarizer accidented spot and etc	Minor	
6	Soldering appearance	Good soldering, Peeling off is not allowed		
O	Soldering appearance	and etc		
7	LCD/Polarizer	Black/White spot/line, scratch, crack, etc.		

**Note1:** a) Light dot: Dots appear bright and unchanged in size in which LCD panel is displaying under black pattern.

b) Dim dot: Dots appear dark and unchanged in size in which LCD panel is displaying under pure red, green, blue picture.

# 8.1.4 Criteria (Visual)

Number	Items	Criteria(mm)
1.0 LCD Crack/Broken NOTE: X: Length Y: Width Z: Height L: Length of ITO, T: Height of LCD	(1) The edge of LCD broken	X Y Z <inner border="" line="" of="" t<="" td=""></inner>
		≤3.0mm the seal
	(2)LCD corner broken	X         Y         Z           ≤3.0mm         ≤L         ≤T
	(3) LCD crack	Crack Not allowed

Spot defect

2.0

Φ=(X+Y)/2

Zone	Acceptal	ole Qty		
Size (mm)	A B		С	
Ф≤0.15	Ignore			
0.15<Φ≤0.25	3(distance ≥ 10mm)	lanoro		
0.25<Φ≤0.4	2(distance ≥ 10mm)	- Ignore		
Ф>0.4	0			

Dim spot ( light leakage, dent, dark spot, etc )

Zone	Acceptal	ıble Qty			
Size (mm)	Α	В	С		
Ф≤0.15	Ignore				
0.15<Φ≤0.25	3( distance ≥ 10mm) Ignore				
0.25<Φ≤0.4	2( distance ≥ 10mm)	ignore			
Ф>0.4	0				

③ Polarizer accidented spot

Zone	A	
Size (mm)	Α	С
Ф≤0.2	Igno	
0.2<Φ≤0.5	2( distance	Ignore
Ф>0.5	0	

#### 4 Polarizer Bubble

Zone	Acceptable Qty				
Size (mm)	Α	С			
Ф≤0.2	Ignore				
0.2<Φ≤0.4	2(distance≧10mm)		Ignore		
0.4<Φ≤0.5	1		ignore		
Φ>0.5	0				

3.0	LCD Pixel defect	Pixel bad points			
		Item	Zone A	Acceptable Qty	
			Random	N≤2	
		Bright dot	2 dots adjacent	N≤0	
			3 dots adjacent	N≤0	
			Random	N≤3	
		Dark dot	2 dots adjacent	N≤0	
			3 dots adjacent	N≤0	
	Distance	<ol> <li>Minimum Distance Between Bright dots.</li> <li>Minimum Distance Between dark dots</li> <li>Minimum Distance Between dark and bright dot.</li> </ol>	5mm		
		Total bright and dark dot		N≤4	
		Note:			
		A) Bright dot	d in size in which		
		LCD pane			
		B) Dark dot:	Dots appear dark and unchanged in	size in which	
		LCD pane	el is displaying under pure red, green	, blue picture.	
		C) 2 dot adja Picture:	cent = 1 pair = 2 dots		
		2 dot adja	cent 2 dot adjacent		
		2 dot adjacent (vertical) 2 dot adjacent (s		slant)	
		2 doi adjacei	nt (vertical) 2 dot adjacent (	siain,	

	Line defect (LCD					
	/Polarizer backlight	Width(mm)	Length(m	Acce	ptable Q	ty
	black/white line,	vvidtri(iTiiTi)	m)	Α	В	С
	scratch, stain)	Ф≤0.05	Ignore	Ignore		
4.0	Φ ,,,	0.05 <w≤0.06< td=""><td>L≤5.0</td><td>N≤3</td><td></td><td>Ignore</td></w≤0.06<>	L≤5.0	N≤3		Ignore
	Ψ W W: width, L: length	0.06 <w≤0.08< td=""><td>L≤4.0</td><td>N≤2</td><td></td><td></td></w≤0.08<>	L≤4.0	N≤2		
	N : Count	W>0.08 Define as spot defect				
5.0	Electronic Componen ts SMT.	Not allow missing parts, solderless connection, cold solder joint, mi smatch, The positive and negative polarity opposite				
6.0	Display color& Brigh tness.	<ol> <li>Color: Measuring the color coordinates, The measurement standard according to the datasheet or samples.</li> <li>Brightness: Measuring the brightness of White screen, The measurement standard according to the datasheet or Samples.</li> </ol>				
7.0	LCD Mura/Waving/ Hot spot	Not visible through 5% ND filter in 50% gray or judge by limit sample if necessary.				

### Criteria (functional items)

Number	Items	Criteria (mm)
1	No display	Not allowed
2	Missing segment	Not allowed
3	Short	Not allowed
4	Backlight no lighting	Not allowed

## 9. Reliability Test Result

Remark:

Item	Condition	Inspection after test
High Temperature Operating	70°C,96H	
Low Temperature Operating	-20°C, 96HR	
High Temperature Storage	85°C, 96HR	Inspection after 2~4hours
Low Temperature Storage	-30°C, 96HR	storage at room temperature,
High Temperature & High	+60°C, 90% RH ,96 hours.	the sample shall be free from
	-10°C,30 min ↔ +60°C,30 min,	defects:
Thermal Shock (Non-operation)	Change time:5min 20CYC.	1.Air bubble in the LCD; 2.Non-display;
	C_150nE_B_220 Spaints/panel	3.Missing segments/line;
ESD test	Air:±6KV, 5times; Contact:±4KV, 5 times;	4.Glass crack;
	(Environment: 15°C~35°C. 30%~60%).	5.Current IDD is twice higher
	Frequency range:10~55Hz, Stroke:1.5mm	than initial value.
Vibration (Non-operation)	Sweep:10Hz~55Hz~10Hz 2 hours for each direction of	
	X.Y.Z. (6 hours for total) (Package condition).	
Box Drop Test	1 Corner 3 Edges 6 faces,80cm (MEDIUM BOX)	

- 1. The test samples should be applied to only one test item.
- 2. Sample size for each test item is 5~10pcs.
- 3.For Damp Proof Test, Pure water(Resistance >  $10M\Omega$ ) should be used.
- 4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.
- 5. Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

## 10. Cautions and Handling Precautions

### 10.1 Handling and Operating the Module

- (1) When the module is assembled, it should be attached to the system firmly.
- Do not warp or twist the module during assembly work.
- (2) Protect the module from physical shock or any force. In addition to damage, this may cause improper operation or damage to the module and back-light unit.
- (3) Note that polarizer is very fragile and could be easily damaged. Do not press or scratch the surface.
- (4) Do not allow drops of water or chemicals to remain on the display surface.
- If you have the droplets for a long time, staining and discoloration may occur.
- (5) If the surface of the polarizer is dirty, clean it using some absorbent cotton or soft cloth.
- (6) The desirable cleaners are water, IPA (Isopropyl Alcohol) or Hexane.
- Do not use ketene type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanent damage to the polarizer due to chemical reaction.
- (7) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, legs, or clothes, it must be washed away thoroughly with soap.
- (8) Protect the module from static; it may cause damage to the CMOS ICs.
- (9) Use finger-stalls with soft gloves in order to keep display clean during the incoming inspection and assembly process.
- (10) Do not disassemble the module.
- (11) Protection film for polarizer on the module shall be slowly peeled off just before use so that the electrostatic charge can be minimized.
- (12) Pins of I/F connector shall not be touched directly with bare hands.
- (13) Do not connect, disconnect the module in the "Power ON" condition.
- (14) Power supply should always be turned on/off by the item 6.1 Power On Sequence &6.2 Power Off Sequence

#### 10.2 Storage and Transportation.

- (1) Do not leave the panel in high temperature, and high humidity for a long time.
- It is highly recommended to store the module with temperature from 0 to 35 °C and relative humidity of less than 70%
- (2) Do not store the TFT-LCD module in direct sunlight.
- (3) The module shall be stored in a dark place. When storing the modules for a long time, be sure to adopt effective measures for protecting the modules from strong ultraviolet radiation, sunlight, or fluorescent light.
- (4) It is recommended that the modules should be stored under a condition where no condensation is allowed. Formation of dewdrops may cause an abnormal operation or a failure of the module.
- In particular, the greatest possible care should be taken to prevent any module from being operated where condensation has occurred inside.
- (5) This panel has its circuitry FPC on the bottom side and should be handled carefully in order not to be stressed.